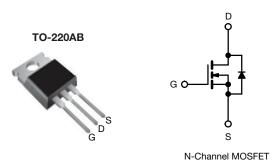
Vishay Siliconix

E Series Power MOSFET With Fast Body Diode and Low Gate Charge



www.vishay.com

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.127			
Q _g (Max.) (nC)	75				
Q _{gs} (nC)	17				
Q _{gd} (nC)	19				
Configuration	Single				

FEATURES

- Reduced figure-of-merit (FOM): $R_{\text{on}} \ x \ Q_{g}$
- Fast body diode MOSFET using E series
- technology
 Reduced t_{rr}, Q_{rr}, and I_{RRM}
- Increased robustness due to low Q_{rr}
- Low input capacitance (C_{iss})
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Computing
 - ATX power supplies
- Industrial
- Welding
- Induction heating
- Battery chargers
- Uninterruptible power supplies (UPS)
- Renewable energy
 - String PV inverters

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free and halogen-free	SiHP25N60EFL-BE3 ^a			
	SiHP25N60EFL-GE3			

Note

a. "-BE3" denotes alternate manufacturing location

ABSOLUTE MAXIMUM RATINGS (T_C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	600	v
Gate-source voltage			V _{GS}	± 30	v
Continuous drain current (T _J = 150 °C)	V =======V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$		25	
	V _{GS} at 10 V	T _C = 100 °C	I _D	16	А
Pulsed drain current ^a			I _{DM}	61	
Linear derating factor				2	W/°C
Single pulse avalanche energy ^b			E _{AS}	353	mJ
Maximum power dissipation			P _D	250	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope	T _J = 125 °C		d)//dt	70	\//no
Reverse diode dV/dt d			dV/dt	15	V/ns
Soldering recommendations (peak temperature) ^c	For 10 s			300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5 A

c. 1.6 mm from case

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RoHS

COMPLIANT HALOGEN

FREE



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d. $I_{SD} \leq I_D, \, dl/dt$ = 100 A/µs, starting T_J = 25 $^\circ C$

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W
Maximum junction-to-case (drain)	R _{thJC}	-	0.5	0/10

PARAMETER	SYMBOL	TES	TEST CONDITIONS			MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} =	600	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I _D = 10 mA		0.69	-	V/°C
Gate-source threshold Voltage (N)	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		-	5.0	V
		$V_{GS} = \pm 20 V$		-	-	± 100	nA
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30 \text{ V}$		-	± 1	μA
Zere gete voltege drein overent	1	V _{DS} =	$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$		-	1	μA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V			-	500	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	l _D = 12.5 A	-	0.127	0.146	Ω
Forward transconductance	9 _{fs}	V _{DS} =	30 V, I _D = 12.5 A	-	11.3	-	S
Dynamic					•		
Input capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 100 V,		-	2274	-	pF
Output capacitance	C _{oss}			-	137	-	
Reverse transfer capacitance	C _{rss}		f = 1 MHz		4	-	
Effective output capacitance, energy related ^a	C _{o(er)}			-	79	-	
Effective output capacitance, time related ^b	C _{o(tr)}	$V_{\rm DS} = 0$	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		330	-	
Total gate charge	Qg			-	50	75	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	V _{GS} = 10 V I _D = 12.5 A, V _{DS} = 480 V	-	17	-	nC
Gate-drain charge	Q _{gd}			-	19	-	
Turn-on delay time	t _{d(on)}			-	25	50	
Rise time	t _r	V _{DD} = 480 V, I _D = 12.5 A,		-	39	68	- ns
Turn-off delay time	t _{d(off)}		$R_g = 9.1 \Omega, V_{GS} = 10 V$		47	94	
Fall time	t _f			-	21	42	
Gate input resistance	R _g	f = 1 MHz, open drain		0.4	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	s	•			•	•	•
Continuous source-drain diode current	I _S	MOSFET sym showing the	MOSFET symbol		-	25	•
Pulsed diode forward current	I _{SM}	integral reverse p - n junction diode		-	-	61	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 12.5 A, V _{GS} = 0 V		-	0.9	1.2	V
Reverse recovery time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 12.5 \text{ A},$ dl/dt = 100 A/ μ s, V _R = 25 V		-	138	276	ns
Reverse recovery charge	Q _{rr}			-	0.8	1.6	μC
Reverse recovery current	I _{RRM}			-	11	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. Coss(r) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

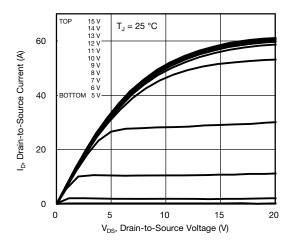


Fig. 1 - Typical Output Characteristics

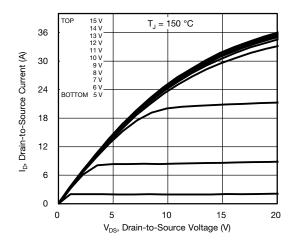


Fig. 2 - Typical Output Characteristics

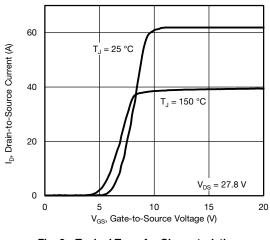


Fig. 3 - Typical Transfer Characteristics

3.0 12.5 A R_{DS(on)}, Drain-to-Source On-Resistance 2.5 2.0 (Normalized) 1.0 0.5 0 -40 -20 -60 0 20 40 60 80 100 120 140 160 T_., Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

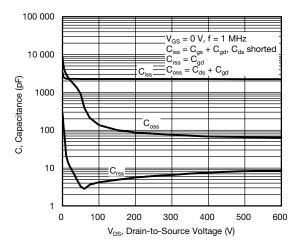


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

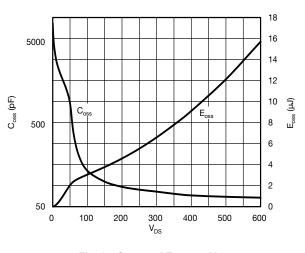


Fig. 6 - C_{OSS} and E_{OSS} vs. V_{DS}

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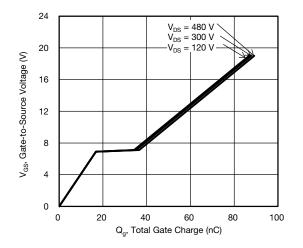


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

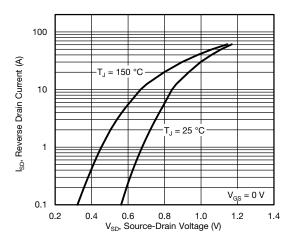


Fig. 8 - Typical Source-Drain Diode Forward Voltage

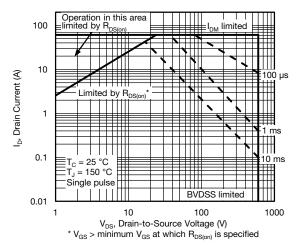


Fig. 9 - Maximum Safe Operating Area

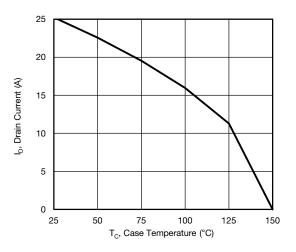


Fig. 10 - Maximum Drain Current vs. Case Temperature

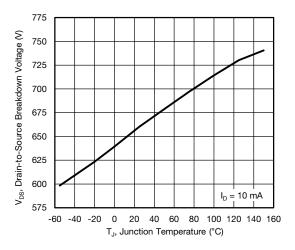
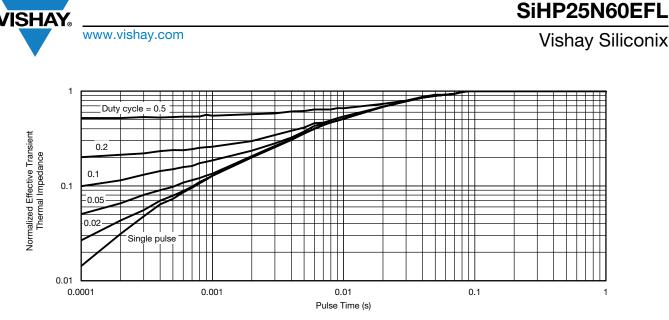


Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature

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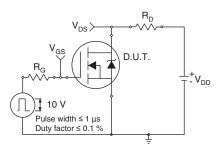


Fig. 13 - Switching Time Test Circuit

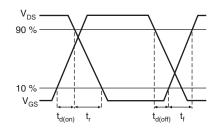


Fig. 14 - Switching Time Waveforms

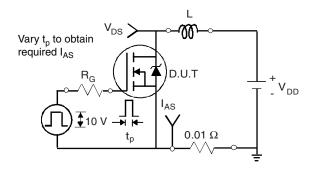


Fig. 15 - Unclamped Inductive Test Circuit

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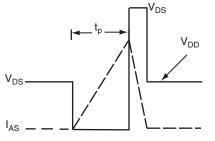


Fig. 16 - Unclamped Inductive Waveforms

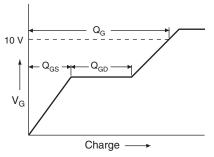


Fig. 17 - Basic Gate Charge Waveform

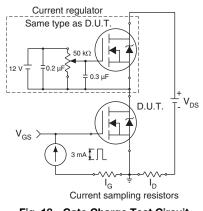


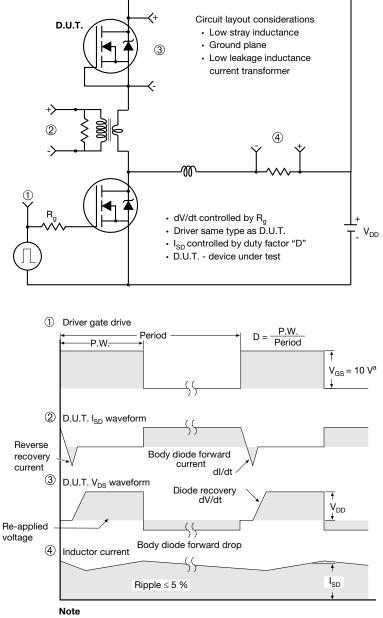
Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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